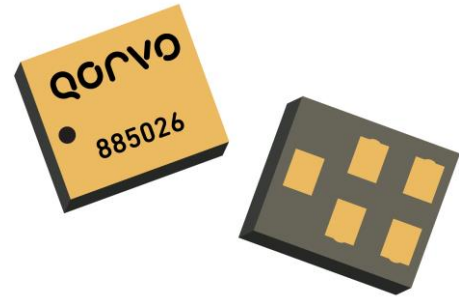


General Description

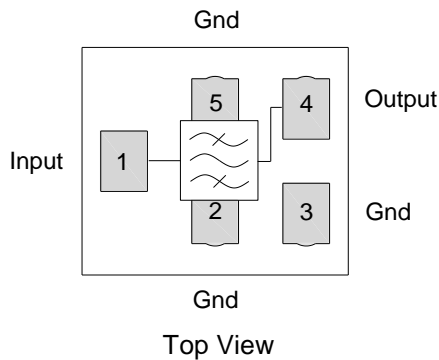
The 885026 is a high-performance Bulk Acoustic Wave (BAW) filter designed to meet the strict LTE rejection requirements for use in B38.

885026 is specifically designed to meet the high-performance expectations of insertion loss and rejection for LTE transmit systems under all operating conditions.

The 885026 uses common module packaging techniques to achieve the industry standard 1.4 x 1.2 x 0.46 mm footprint.



Functional Block Diagram



Pin Configuration – Single Ended

| Pin No. | Label |
|---------|--------|
| 1 | Input |
| 4 | Output |
| 2,3,5 | Ground |

Product Features

- Highly selective BAW filter achieving low insertion loss over full bandwidth and operating conditions
- Rejection in WLAN band of 40dB minimum
- Rejection in Band 7 Rx band of 10dB minimum
- Performance -20 to +90 °C
- Ceramic chip-scale Package (CSP)
- Small Size: 1.4 x 1.2 x 0.46 mm
- Hermetically Sealed
- RoHS compliant, Pb-free

Applications

- For Band 38 TD-LTE applications
- B7/B38/B40 LTE handset, data cards, mobile routers

Ordering Information

| Part No. | Description |
|------------|------------------|
| 885026 | Packaged part |
| 885026-EVB | Evaluation board |

Standard T/R size = 10,000 units/reel

Absolute Maximum Ratings

| Parameter | Rating |
|----------------------------------|----------------|
| Storage Temperature | -40 to +125 °C |
| Operable Temperature | -40 to +90 °C |
| RF Input Power, CW, 50Ω, T=25 °C | +29dBm |

Note: Operation of this device outside the parameter ranges given may cause permanent damage.

MTTF

| Parameter | Min |
|---|-------------|
| RF Input Power +29dBm, CW, in band at 55 °C | 10,000 hrs. |

Electrical Specifications ⁽¹⁾⁽²⁾

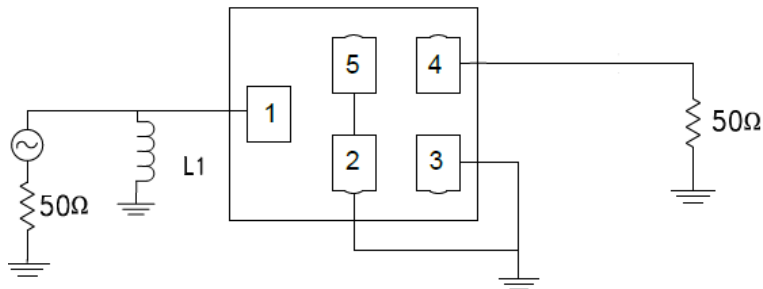
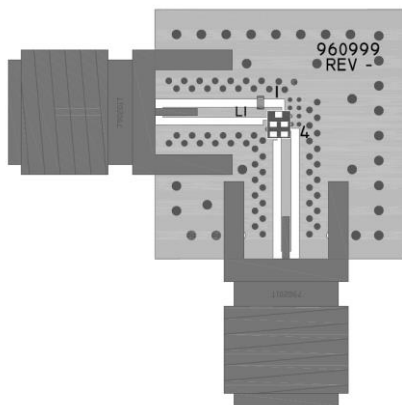
Conditions unless otherwise noted: ⁽³⁾ Device Temperature = 0°C to +70°C.

| Parameter ⁽²⁾ | Conditions | Min | Typ | Max | Units |
|--------------------------------------|--------------------------------|-----|--------|--------------------|-------|
| Center Frequency | | - | 2595 | | dB |
| Insertion Loss | 2570 – 2620 MHz | - | 1.5 | 2.5 | dB |
| | 2570 – 2620 MHz | | 1.5 | 2.1 ⁽⁴⁾ | dB |
| Attenuation ⁽⁵⁾ | 10 – 1574 MHz | 30 | 33 | - | dB |
| | 1559 – 1606 MHz | 33 | 34 | - | |
| | 1607 – 2300 MHz | 32 | 34 | - | |
| | 2400 – 2500 MHz | 39 | 41 | - | |
| | 2505 – 2535 MHz ⁽⁶⁾ | 20 | 37 | - | |
| | 2645 – 2670 MHz | 10 | 16 | - | |
| | 5150 – 5230 MHz | 30 | 39 | - | |
| 7725 – 7845 MHz | 25 | 32 | - | | |
| Input VSWR | 2570 – 2620 MHz | - | 1.6 :1 | 2.0:1 | - |
| Output VSWR | 2570 – 2620 MHz | - | 1.6 :1 | 2.0:1 | - |
| Source/Load Impedance ⁽⁷⁾ | Single-ended | - | 50 | - | Ω |

Notes:

1. All specifications are based on the test circuit shown on page 3
2. Electrical margin has been built into the design to account for the variations due to manufacturing tolerances.
3. In production, devices will be tested at room temperature to a guard-banded specification to ensure electrical compliance over temperature
4. At 25 °C only
5. Measurement made relative to zero dB
6. Specified from 0°C to +55°C only.
7. This is the optimum impedance in order to achieve the performance shown.

Evaluation Board



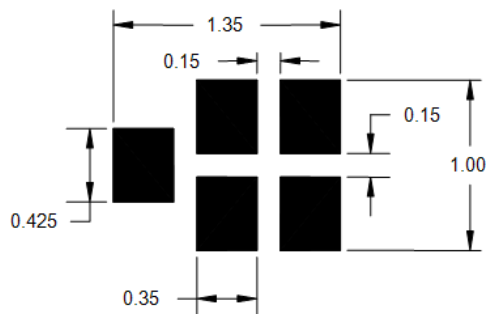
Notes:

1. Matching component values shown are for the specified TriQuint evaluation board. Value adjustment may be required in end user product circuits depending on component manufacturer and PCB material.
2. PCB: .500 x .500 x .062; Construction: ½ oz. Cu Top Layer; TLY-5A (.0075) ½ oz. Cu Middle Layer, FR4; ½ oz. Cu Bottom Layer. (dimensions are in inches)

Bill of Material

| Reference Des. | Value | Description | Manuf. | Part Number |
|----------------|-------|-------------------------|-------------|---------------|
| L1 | 20 nH | 0201 chip inductors ±3% | MuRata | LQP03TN20NH02 |
| SMA | N/A | SMA connector | Radiall USA | 9602-1111-018 |
| PCB | N/A | 3-layer | Multiple | 960999 |

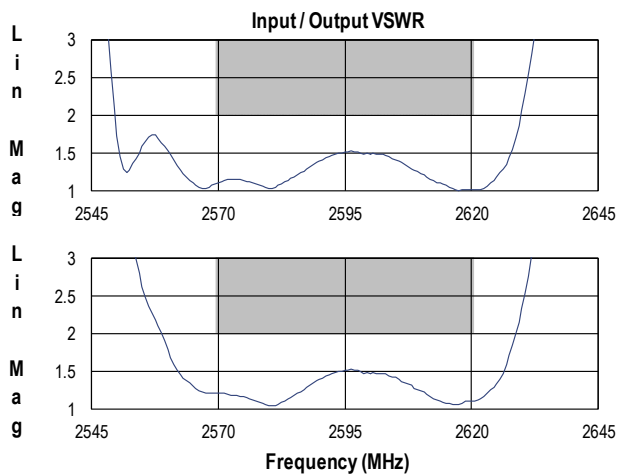
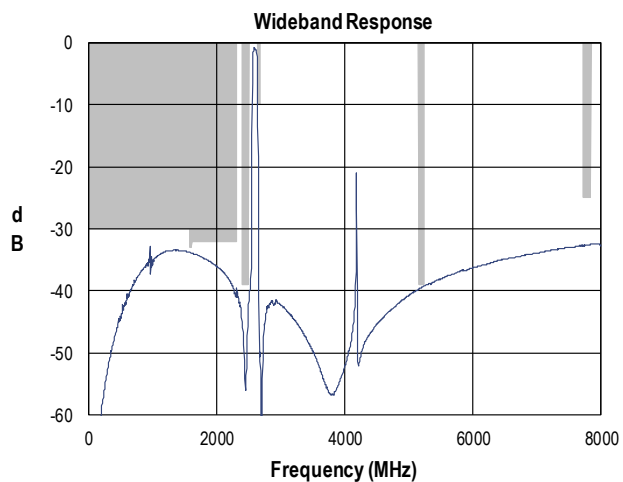
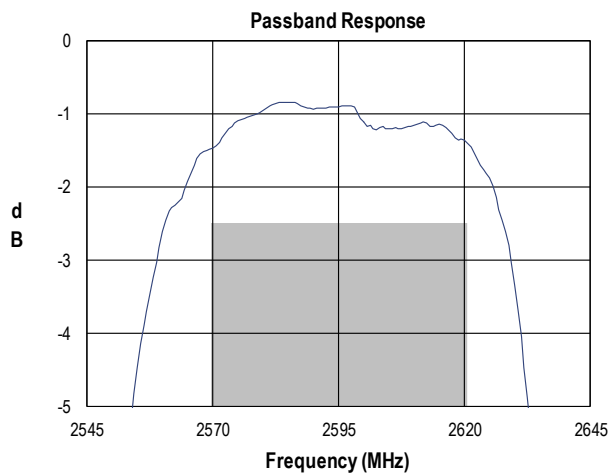
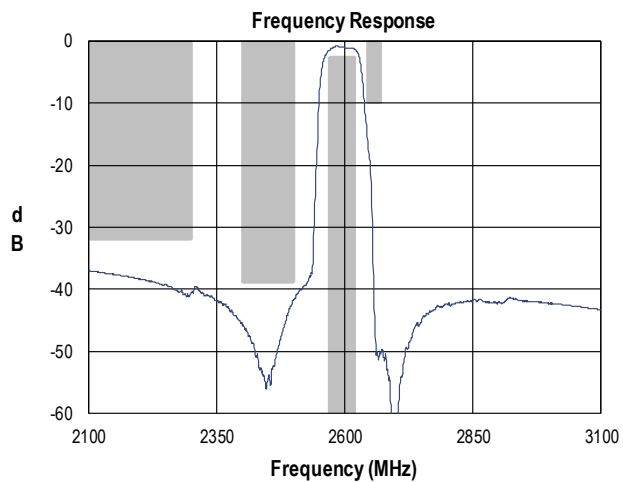
PCB Mounting Pattern



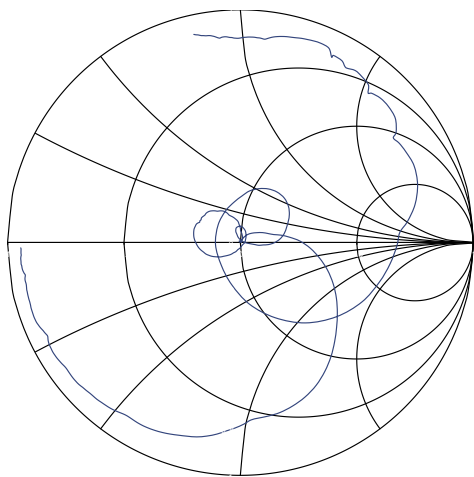
Notes:

1. All dimensions are in millimeters. Angles are in degrees.
2. This drawing specifies the mounting pattern used on the Qorvo evaluation board for this product. Some modification may be necessary to suit end user assembly materials and processes.

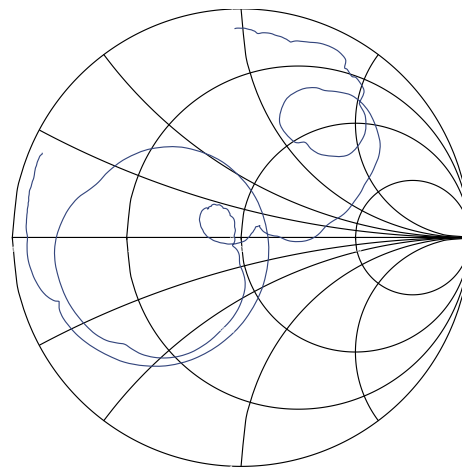
Performance Plots



Input Smith Chart



Output Smith Chart



Handling Precautions

| Parameter | Rating | Standard |
|----------------------------------|----------|---------------------|
| ESD – Human Body Model (HBM) | Class 1C | ESDA / JEDEC JS-001 |
| ESD – Charge Device Model (CDM) | Class C1 | ESDA/JEDEC JS-002 |
| MSL – Moisture Sensitivity Level | N/A * | Hermetic package |

*Hermetically sealed ceramic package



Caution!
ESD-Sensitive Device

Solderability

Compatible with both lead-free (260°C max. reflow temp.) and tin/lead (245°C max. reflow temp.) soldering processes. Solder profiles available upon request.

RoHS Compliance

This part is compliant with 2011/65/EU RoHS directive (Restrictions on the Use of Certain Hazardous Substances in Electrical and Electronic Equipment) as amended by Directive 2015/863/EU. This product also has the following attributes:

- Lead Free
- Halogen Free (Chlorine, Bromine)
- Antimony Free
- TBBP-A (C₁₅H₁₂Br₄O₂) Free
- PFOS Free
- SVHC Free



Contact Information

For the latest specifications, additional product information, worldwide sales and distribution locations:

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Tel: 1-844-890-8163
Email: customer.support@qorvo.com

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- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



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